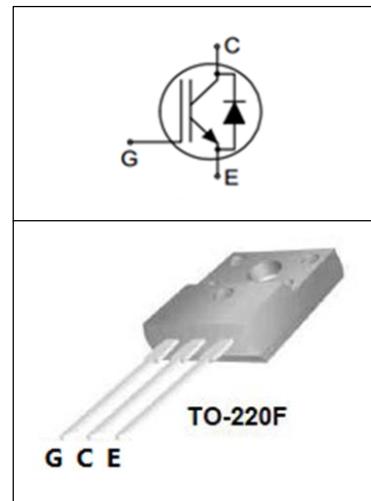


## IGBT

### Features

- 1200V,15A
- $V_{CE(sat)(typ.)}=1.9V$  @ $V_{GE}=15V, I_C=15A$
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA



### General Description

JIAEN Trench IGBTs offer lower losses and higher energy efficiency for application such as IH (induction heating), UPS, general inverter and other soft switching applications.

1)

### Absolute Maximum Ratings

Symbol	Parameter	Value	Units
$V_{CES}$	Collector-Emitter Voltage	1200	V
$V_{GES}$	Gate-Emitter Voltage	$\pm 30$	V
$I_C$	Continuous Collector Current ( $T_c=25^\circ\text{C}$ ) <sup>1) 2)</sup>	14	A
	Continuous Collector Current ( $T_c=100^\circ\text{C}$ ) <sup>1) 2)</sup>	7	A
$I_{CM}$	Pulsed Collector Current <sup>1)</sup>	45	A
$I_F$	Diode Continuous Forward Current ( $T_c=100^\circ\text{C}$ )	7	A
$I_{FM}$	Diode Maximum Forward Current <sup>1)</sup>	45	A
$t_{sc}$	Short Circuit Withstand Time	10	us
$P_D$	Maximum Power Dissipation ( $T_c=25^\circ\text{C}$ )	32	W
	Maximum Power Dissipation ( $T_c=100^\circ\text{C}$ )	13	W
$T_J$	Operating Junction Temperature Range	-40 to +150	°C
$T_{STG}$	Storage Temperature Range	-55 to +150	°C

### Thermal Characteristics

Symbol	Parameter	Max.	Units
$R_{th j-c}$	Thermal Resistance, Junction to case for IGBT	3.8	°C/W
$R_{th j-c}$	Thermal Resistance, Junction to case for Diode	4.2	°C/W
$R_{th j-a}$	Thermal Resistance, Junction to Ambient	65	°C/W

### Electrical Characteristics ( $T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$BV_{CES}$	Collector-Emitter Breakdown Voltage	$V_{GE}=0V, I_C=250\mu A$	1200	-	-	V
$I_{CES}$	Collector-Emitter Leakage Current	$V_{CE}=1200V, V_{GE}=0V$	-	-	100	$\mu A$
$I_{GES}$	Gate Leakage Current, Forward	$V_{GE}=30V, V_{CE}=0V$	-	-	100	nA
	Gate Leakage Current, Reverse	$V_{GE}=-30V, V_{CE}=0V$	-	-	100	nA
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE}=V_{CE}, I_C=250\mu A$	4.5	-	6.5	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15V, I_C=15A$	-	1.9	2.4	V
$Q_g$	Total Gate Charge	$V_{CC}=600V$ $V_{GE}=15V$ $I_C=15A$	-	120		nC
$Q_{ge}$	Gate-Emitter Charge		-	50		nC
$Q_{gc}$	Gate-Collector Charge		-	15		nC
$t_{d(on)}$	Turn-on Delay Time	$V_{CC}=600V$ $V_{GE}=15V$ $I_C=15A$ $R_G=10\Omega$ Inductive Load $T_c=25^\circ C$	-	20	-	ns
$t_r$	Turn-on Rise Time		-	30	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	150	-	ns
$t_f$	Turn-off Fall Time		-	95	-	ns
$E_{on}$	Turn-on Switching Loss		-	2.8	-	mJ
$E_{off}$	Turn-off Switching Loss		-	0.6	-	mJ
$E_{ts}$	Total Switching Loss		-	3.4	-	mJ
$C_{ies}$	Input Capacitance	$V_{CE}=25V$ $V_{GE}=0V$ $f = 1MHz$	-	2300	-	pF
$C_{oes}$	Output Capacitance		-	95	-	pF
$C_{res}$	Reverse Transfer Capacitance		-	45	-	pF

### Electrical Characteristics of Diode ( $T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_F$	Diode Forward Voltage	$I_F=15A$	-	1.9	2.6	V
$t_{rr}$	Diode Reverse Recovery Time	$V_{CE} = 600V$ $I_F = 15A$ $dI_F/dt = 200A/us$	-	230		ns
$I_{rr}$	Diode peak Reverse Recovery Current		-	27		A
$Q_{rr}$	Diode Reverse Recovery Charge		-	1260		nC

note:

- 1) Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2) Limited by thermal resistance.



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## Typical Performance Characteristics

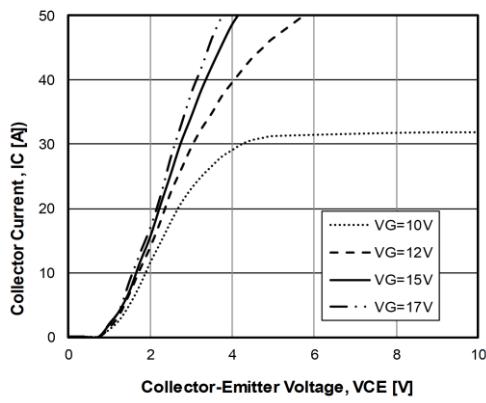


Fig 1. Output characteristics

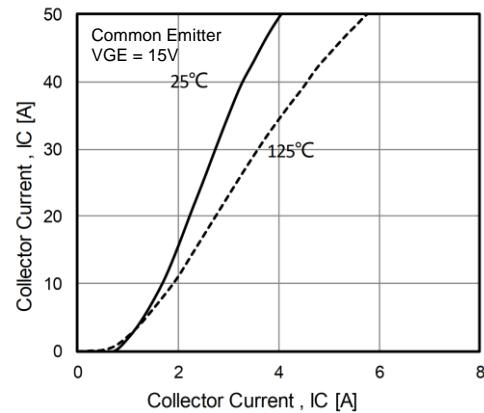


Fig 2. Typical Saturation Voltage Characteristics

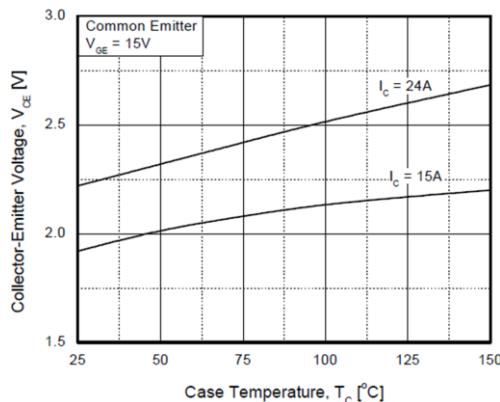


Figure 3. Saturation Voltage vs. Case Temperature at Variant Current Level

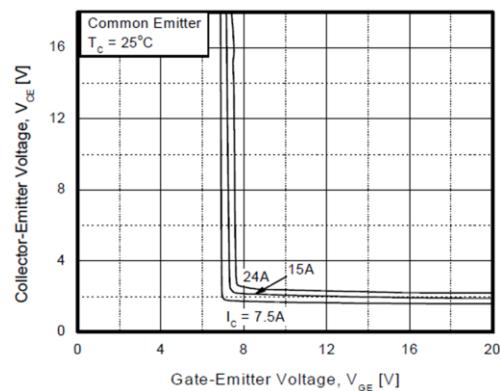


Figure 4. Saturation Voltage vs. VGE

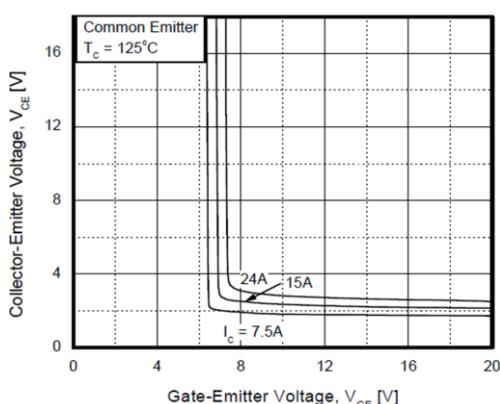


Figure 5. Saturation Voltage vs. VGE

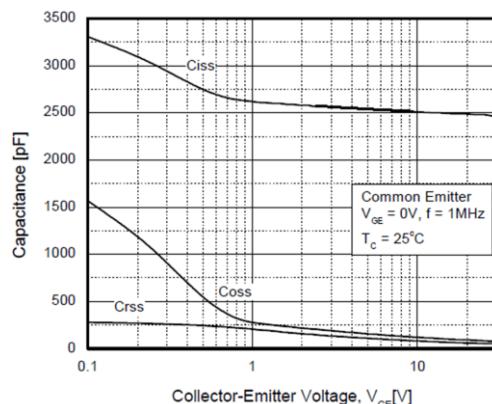


Figure 6. Capacitance Characteristics



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## Typical Performance Characteristics

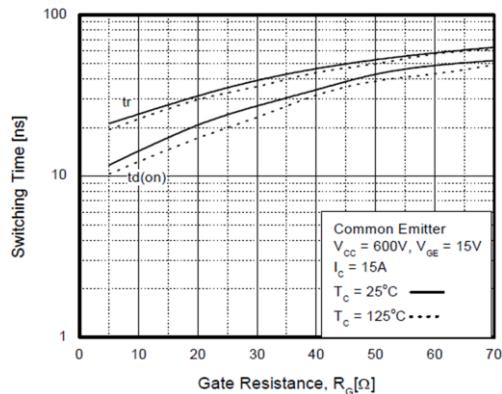


Figure 7. Turn-On Characteristics vs. Gate Resistance

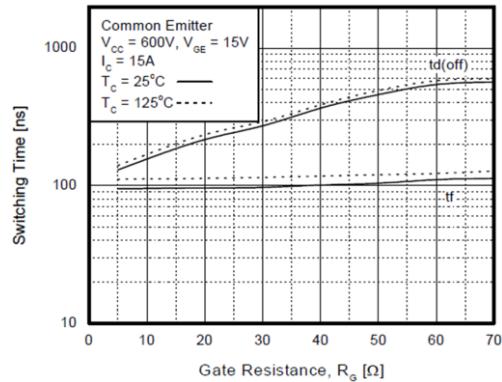


Figure 8. Turn-Off Characteristics vs. Gate Resistance

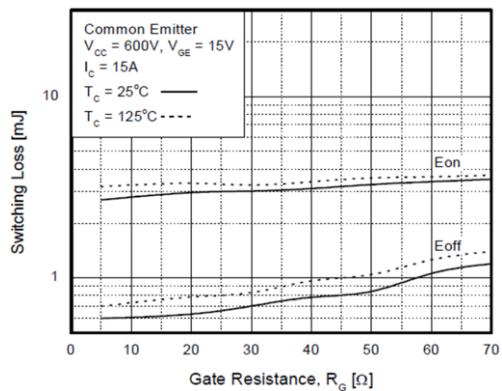


Figure 9. Switching Loss vs. Gate Resistance

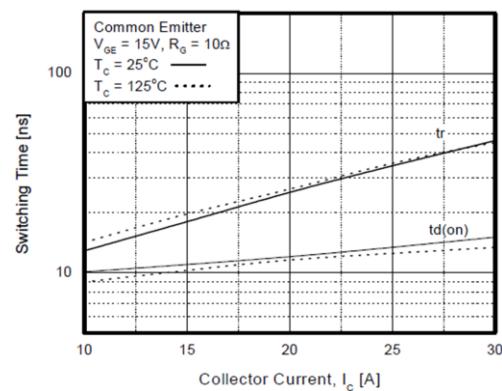


Figure 10. Turn-On Characteristics vs. Collector Current

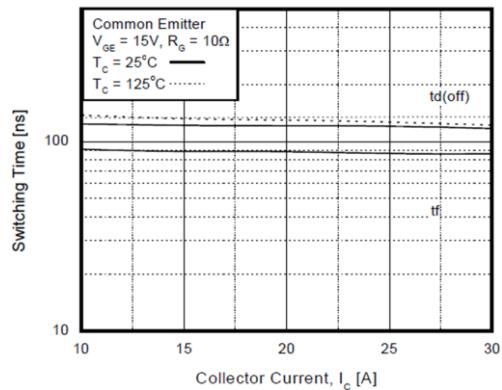


Figure 11. Turn-Off Characteristics vs. Collector Current

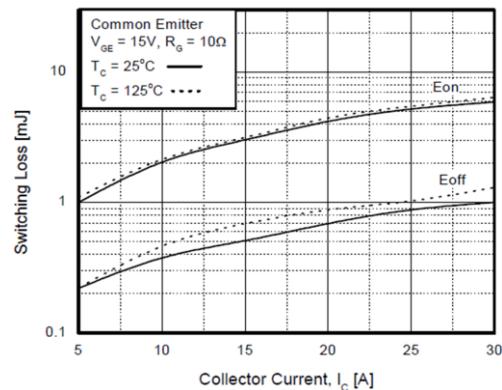


Figure 12. Switching Loss vs. Collector Current



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## Typical Performance Characteristics

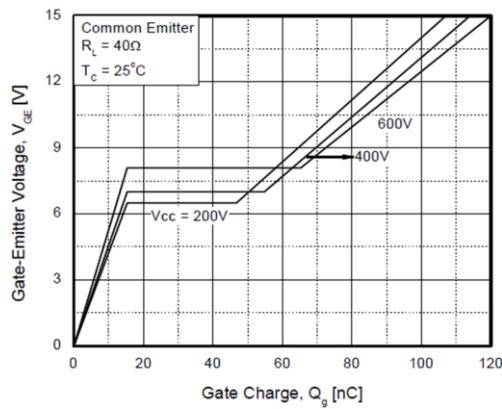


Figure 13. Gate Charge Characteristics

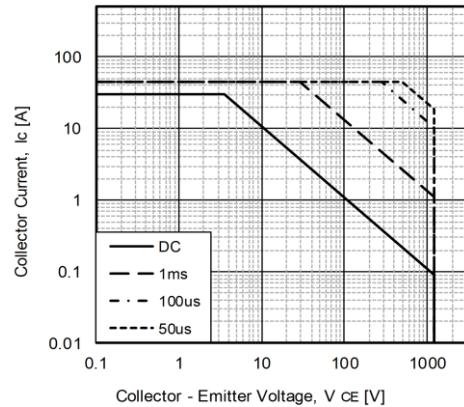


Figure 14. SOA Characteristics <sup>3)</sup>

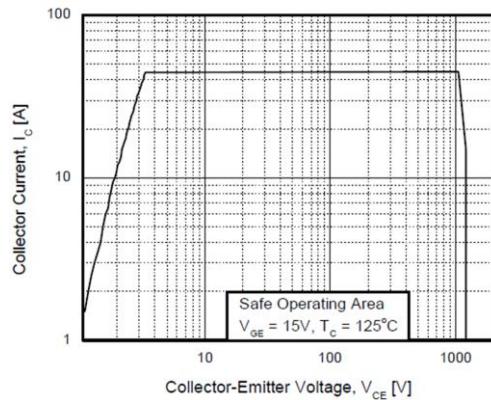


Figure 15. Turn-Off SOA <sup>3)</sup>

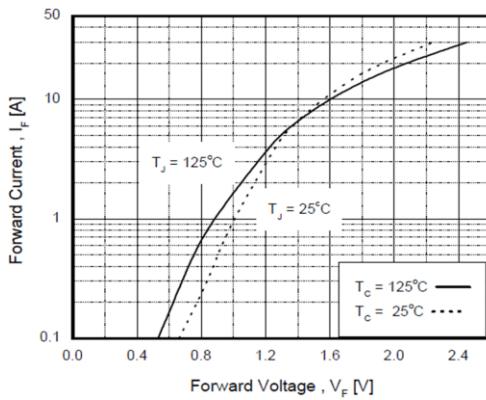


Figure 16. Forward Characteristics

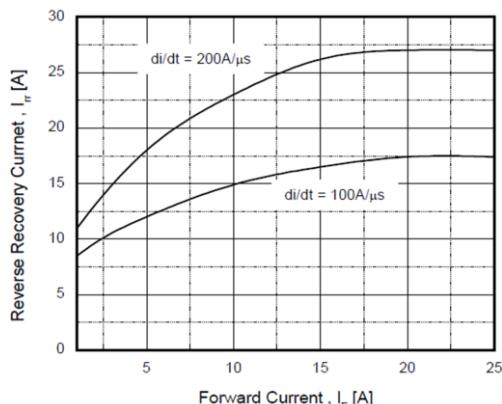


Figure 17. Reverse Recovery Current

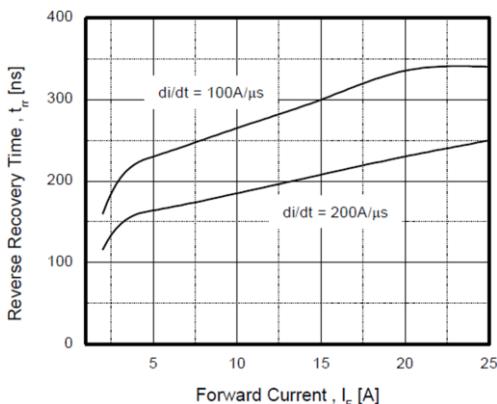


Figure 18. Reverse Recovery Time



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## Typical Performance Characteristics

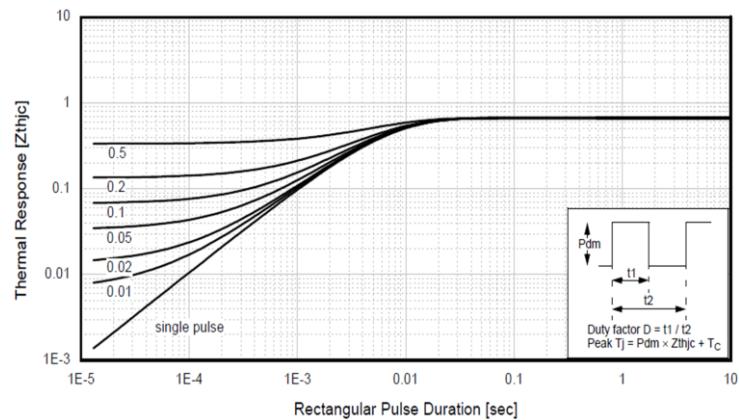


Figure 19. Transient Thermal Impedance of IGBT 3)

note:

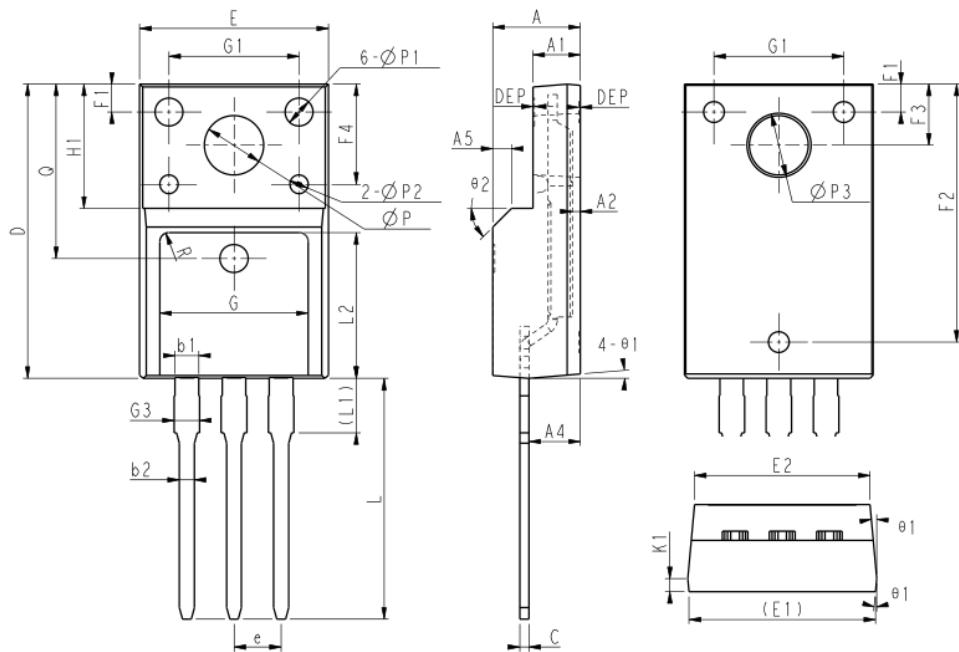
- 3) Limited by maximum thermal resistance. Applicable for TO220 standard package.



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## TO-220F-3L PACKAGE OUTLINE



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